

<b>PCN Number:</b>	20230210000.1A	<b>PCN Date:</b>	May 22, 2023
<b>Title:</b>	Qualification of TI CDAT as Additional Assembly Site for Select QFN Package Device		
<b>Customer Contact:</b>	<a href="#">PCN Manager</a>	<b>Dept:</b>	Quality Services
<b>Proposed 1<sup>st</sup> Ship Date:</b>	June 08, 2023	<b>Sample requests accepted until:</b>	June 23, 2023*

\*Sample requests received after (June 23, 2023) will not be supported.

<b>Change Type:</b>			
<input checked="" type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Data Sheet
<input checked="" type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input checked="" type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
		<input type="checkbox"/>	Wafer Bump Site
		<input type="checkbox"/>	Wafer Bump Material
		<input type="checkbox"/>	Wafer Bump Process
		<input type="checkbox"/>	Wafer Fab Site
		<input type="checkbox"/>	Wafer Fab Materials
		<input type="checkbox"/>	Wafer Fab Process

### PCN Details

#### Description of Change:

**Revision A** is to announce the addition of new devices that were not included on the original PCN notification. These new devices are highlighted and **bolded** in the device list below under **Group 2**. The expected first shipment date for these new devices will be 90 days from this notice (Aug 23, 2023) for these newly added devices only. The proposed 1<sup>st</sup> ship date of June 08, 2023 still applies for the original set of devices.

Texas Instruments Incorporated is announcing the qualification TI CDAT as Additional Assembly Site for select device listed in the "Product Affected" Section. Current assembly sites and Material differences are as follows.

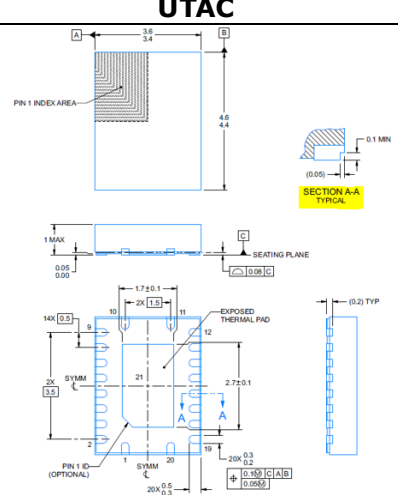
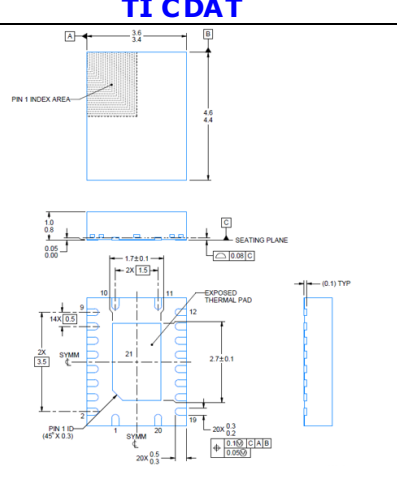
Assembly Site	Assembly Site Origin	Assembly Country Code	Assembly Site City
UTAC	NSE	THA	Bangkok
<b>TI CDAT</b>	<b>CDA</b>	<b>CHN</b>	<b>Chengdu</b>

#### Group 1 Devices:

#### Material Differences:

	UTAC	TI CDAT
Mount Compound	PZ0035	<b>4207123</b>
Wire Type	1mil Cu	<b>0.8mil Cu</b>
Lead finish	Matte Sn	<b>NiPdAu</b>

#### Package Outline Differences:

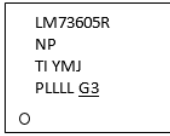
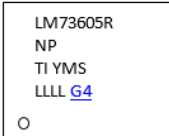
UTAC	TI CDAT
 <p>UTAC package outline diagrams showing dimensions and features. Key features include: PIN 1 INDEX AREA, SEATING PLANE, EXPOSED THERMAL PAD, and WETTABLE FLANK. Dimensions include 3.6, 3.4, 4.5, 4.4, 1.7±0.1, 2.7±0.1, 14X [2.3], 2X [1.5], 2X [3.3], 20X 0.3, 20X 0.5, 0.150 [C] [A] [B], 0.050 [D] [E], 0.150 [C] [A] [B], 0.050 [D] [E].</p>	 <p>TI CDAT package outline diagrams showing dimensions and features. Key features include: PIN 1 INDEX AREA, SEATING PLANE, EXPOSED THERMAL PAD, and NON-WETTABLE FLANK. Dimensions include 3.6, 3.4, 4.5, 4.4, 1.7±0.1, 2.7±0.1, 14X [2.3], 2X [1.5], 2X [3.3], 20X 0.3, 20X 0.5, 0.150 [C] [A] [B], 0.050 [D] [E], 0.150 [C] [A] [B], 0.050 [D] [E].</p>
<b>Wettable Flank</b>	<b>Non-Wettable Flank</b>

**Group 2 Devices:**

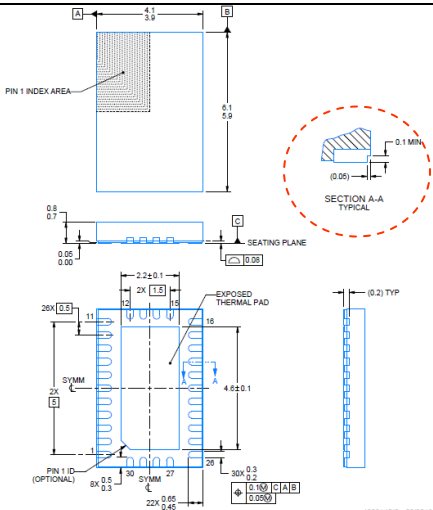
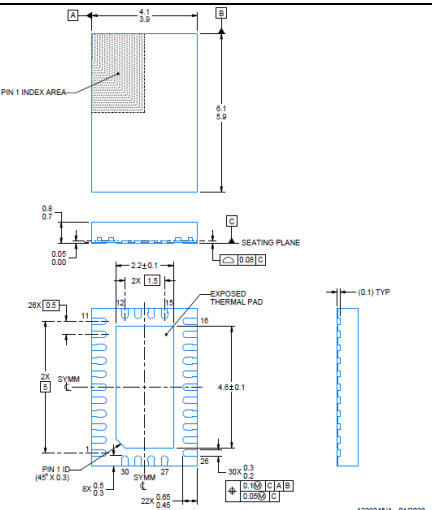
**Material Differences:**

	<b>UTAC</b>	<b>TI CDAT</b>
Mount Compound	PZ0035	4207123
Lead finish	Matte Sn	NiPdAu

**Marking Differences:**

	<b>UTAC</b>	<b>TI Chengdu</b>
RNP Package	 <p>LM73605R NP TI YMJ PLLLL <b>G3</b></p> <p>O</p> <p>TI = TI LETTERS YM = YEAR MONTH DATE CODE J = PRIMARY SITE CODE P = SECONDARY SITE CODE LLLL = ASSEMBLY LOT CODE O = PIN 1 INDICATOR</p>	 <p>LM73605R NP TI YMS PLLLL <b>G4</b></p> <p>O</p> <p>TI = TI LETTERS YM = YEAR MONTH DATE CODE S = ASSEMBLY SITE CODE LLLL = ASSEMBLY LOT CODE O = PIN 1 INDICATOR</p>
ECAT	G3	<b>G4</b>

**Package Outline Differences:**

<b>UTAC</b>	<b>TI CDAT</b>
 <p>Wettable Flank</p> <p>4222145/C 02/2018</p>	 <p>Non-Wettable Flank</p> <p>422945/A 01/2023</p>

**Tape & Reel change:**

<b>What</b>	<b>UTAC</b>	<b>TI CDAT</b>
Reel Width	16.4mm	12.4mm
Carrier Tape Width	16 mm	12mm

**Reason for Change:**

Continuity of supply.

- 1) To align with world technology trends and use wiring with enhanced mechanical and electrical properties
- 2) Maximize flexibility within our Assembly/Test production sites.
- 3) Cu is easier to obtain and stock

**Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):**

None

### Impact on Environmental Ratings:

Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.

RoHS	REACH	Green Status	IEC 62474
<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change

### Changes to product identification resulting from this PCN:

Assembly Site		
UTAC	Assembly Site Origin (22L)	ASO: NSE
TI-CDAT	Assembly Site Origin (22L)	ASO: CDA

Sample product shipping label (not actual product label)



MADE IN: Malaysia  
2DC: 2d:

MSL '2 / 260C / 1 YEAR	SEAL DT
MSL 1 / 235C / UNLIM	03/29/04

OPT:  
ITEM: 39  
LBL: 5A (L)T0:1750



(1P) SN74LS07NSR  
(Q) 2000 (D) 0336  
(31T) LOT: 3959047MLA  
(4W) TKY(1T) 7523483S12  
(P)  
(2P) REV: (V) 0033317  
(20L) CS0: SHE (21L) CCO: USA  
(22L) ASO: MLA (23L) ACO: MYS

### Group 1 Product Affected:

LM25145RGYR	LM25145RGYT	LM5146RGYR
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### Group 2 Product Affected:

LM73605RNPR	LM76002RNPR	LM76005RNPR	LV24640RNPT
LM73605RNPT	LM76002RNPT	LV24540RNPR	
LM73606RNPR	LM76003RNPR	LV24540RNPT	
LM73606RNPT	LM76003RNPT	LV24640RNPR	

## Group 1 Qualification Report

Approve Date 04-Mar-2022

### Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Type	#	Test Name	Condition	Duration	Qual Device:	QBS Reference:	QBS Reference:	QBS Reference:
					LM5146RGYR and LM5145RGYR			
HAST	A2	Biased HAST	130C	96 Hours	QBS	3/231/0	3/231/0	3/231/0
UHAST	A3	Autodave	121C/15psig	96 Hours	QBS	-	3/231/0	3/231/0
UHAST	A3	Unbiased HAST	130C	96 Hours	QBS	3/231/0	-	-
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	QBS	3/231/0	3/231/0	3/231/0

HTSL	A6	High Temperature Storage Life	150C	1000 Hours	QBS	3/135/0	3/135/0	3/135/0
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QBS: Qual By Similarity

Qual Device LM5146RGYR and LM5145RGYR are qualified at MSL2 260C

Quality and Environmental data is available at TI's external Web site: <http://www.ti.com/Green/Pb-free>  
Status: Qualified Pb-Free(SMT) and Green

## Group 2 Qualification Report

Approve Date 09-June-2022

### Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Type	#	Test Name	Condition	Duration	Qual Device: LM7360xRNPR	QBS Reference: TPS61378QWRTERQ1	QBS Reference: PCM6260QRTVRO1	QBS Reference: DRV8703QRHBRO1
HAST	A2	Biased HAST	130C/85%RH	96 Hours	QBS	3/231/0	3/231/0	3/231/0
UHAST	A3	Autoclave	121C/15psig	96 Hours	3/231/0	-	-	-
UHAST	A3	Unbiased HAST	130C/85%RH	96 Hours	QBS	3/231/0	3/231/0	3/231/0
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	3/231/0	-	3/231/0	3/231/0
HTSL	A6	High Temperature Storage Life	150C	1000 Hours	QBS	-	-	3/135/0
HTSL	A6	High Temperature Storage Life	175C	500 Hours	QBS	3/135/0	-	-

QBS: Qual By Similarity

Qual Device LM7360xRNPR family is qualified at MSL2 260C

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours

The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: <http://www.ti.com/>

Green/Pb-free Status: Qualified Pb-Free (SMT) and Green

## Qualification Report

Approve Date 09-June-2022

### Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Type	#	Test Name	Condition	Duration	Qual Device: LM7600xRNPR	Qual Device: LM7360xRNPR	QBS Reference: TPS61378QWRTERQ1	QBS Reference: PCM6260QRTVRO1	QBS Reference: DRV8703QRHBRO1
HAST	A2	Biased HAST	130C/85%RH	96 Hours	QBS		3/231/0	3/231/0	3/231/0
UHAST	A3	Autoclave	121C/15psig	96 Hours	QBS	3/231/0	-	-	-
UHAST	A3	Unbiased HAST	130C/85%RH	96 Hours	QBS		3/231/0	3/231/0	3/231/0
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	QBS	3/231/0	-	3/231/0	3/231/0
HTSL	A6	High Temperature Storage Life	150C	1000 Hours	QBS		-	-	3/135/0
HTSL	A6	High Temperature Storage Life	175C	500 Hours	QBS		3/135/0	-	-

QBS: Qual By Similarity

Qual Device LM7600xRNPR family is qualified at MSL2 260C

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours  
 The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours  
 The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles  
 Quality and Environmental data is available at TI's external Web site: <http://www.ti.com/>  
 Green/Pb-free Status: Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
WW PCN Team	<a href="mailto:PCN_ww_admin_team@list.ti.com">PCN_ww_admin_team@list.ti.com</a>

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